

# 10A, 200V - 600V High Current Density Switchmode Ultrafast Surface Mount Rectifiers

### **FEATURES**

- Very low profile, typical height of 1.1mm
- 175°C operating junction temperature
- Glass passivated chip junction
- Low conduction loss
- Low leakage current
- High forward surge capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition









### **TYPICAL APPLICATIONS**

The devices were designed with a priority on  $V_F$  to minimize the conduction losses as secondary rectification of SMPS, while the diodes remain fast enough to fit applications where the switching frequency is counted in tens of kilohertz. The miniature high power density surface mount packages is perfect for space constraint design.

#### **MECHANICAL DATA**

Case: TO-277A (SMPC)

Molding compound, UL flammability classification rating 94V-0

Moisture sensitivity level: level 1, per J-STD-020

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test **Polarity:** Indicated by cathode band **Weight:** 0.095 g (approximately)

MAXIMUM RATIN	IGS AND ELECTRICA	AL CHARACT	ERISTICS	(T <sub>A</sub> =25°C unl	ess otherwise	noted)	
PARAMETER			SYMBOL	TPMR10D	TPMR10G	TPMR10J	UNIT
Marking code				MR10D	MR10G	MR10J	
Maximum repetitive peak reverse voltage			$V_{RRM}$	200	400	600	V
Maximum average forward rectified current			I <sub>F(AV)</sub>	10		Α	
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load			I <sub>FSM</sub>	150		А	
Maximum instantaneous forward voltage (1) @ 10 A		T <sub>J</sub> =25°C	V <sub>F</sub>	0.95	1.20	1.80	V
		T <sub>J</sub> =125°C		0.86	1.00	-	
Maximum reverse current @ rated $V_R$ $T_J$ =25°C $T_J$ =125°C		I <sub>R</sub>	5	10		μΑ	
			250	500			
Maximum reverse	I <sub>F</sub> =1A, di/dt=-50A/μs, V <sub>R</sub> =30V		t <sub>rr</sub>	60		-	ns
recovery time	I <sub>F</sub> =0.5A, I <sub>R</sub> =1A, I <sub>RR</sub> =0.25A			35		40	
Typical thermal resistance			R <sub>eJL</sub> (2)	8.4		°C/W	
			R <sub>0JA</sub> (3)	78			
Typical junction capacitance (4)			CJ	140		pF	
Operating junction temperature range			$T_J$	- 55 to +175		°C	
Storage temperature range			T <sub>STG</sub>	- 55 to +175		°C	

Note 1: Pulse test with PW=300µs, 1% duty cycle

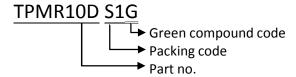
Note 2: Mounted on FR4 PCB with 16mm x 16mm Cu pad area

Note 3: Free air, mounted on recommned pad

Note 4: Measured at 1 MHz and Applied V<sub>R</sub>=4.0 Volts

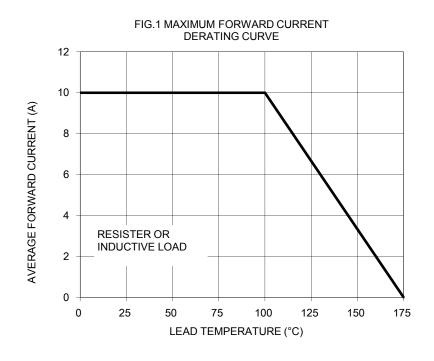


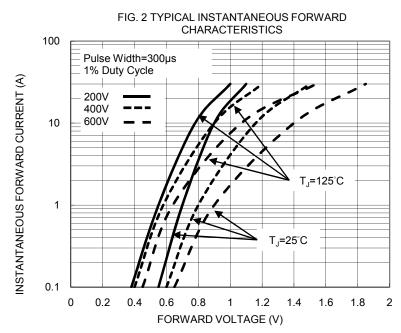
# **ORDER INFORMATION (EXAMPLE)**

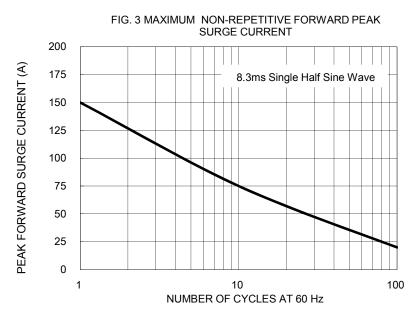


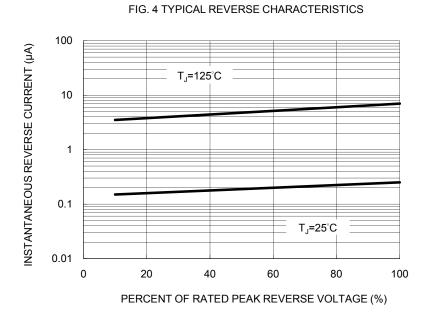
### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub>=25°C unless otherwise noted)



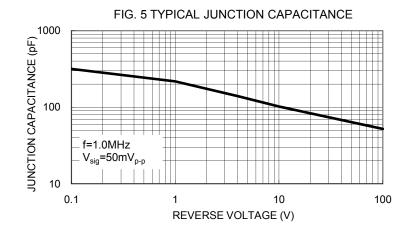




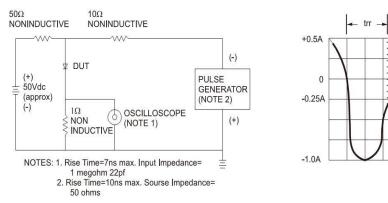


Document Number: DS\_D1501002

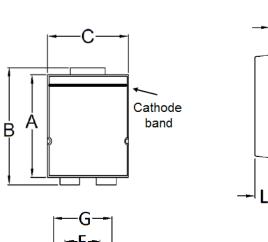


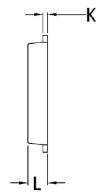


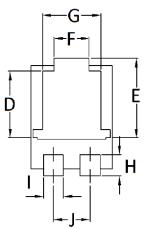
## FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM



# PACKAGE OUTLINE DIMENSIONS TO-277A (SMPC)

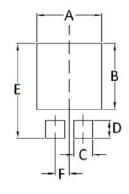






DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min	Max	Min	Max	
Α	5.650	5.750	0.222	0.226	
В	6.350	6.650	0.250	0.262	
С	4.550	4.650	0.179	0.183	
D	3.540	3.840	0.139	0.151	
E	4.235	4.535	0.167	0.179	
F	1.850	2.150	0.073	0.085	
G	3.170	3.470	0.125	0.137	
Н	1.043	1.343	0.041	0.053	
I	1.000	1.300	0.039	0.051	
J	1.930	2.230	0.076	0.088	
K	0.175	0.325	0.007	0.013	
L	1.000	1.200	0.039	0.047	

# **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)		
Α	4.80	0.189		
В	4.72	0.186		
С	1.40	0.055		
D	1.27	0.050		
Е	6.80	0.268		
F	1.04	0.041		

# **MARKING DIAGRAM**



P/N = Marking Code YW = Date Code

F = Factory Code



#### **Notice**

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied,to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or seling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

Document Number: DS\_D1501002 Version: A15